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(54) **SYSTEM AND METHOD FOR THERMAL
MANAGEMENT USING LIQUID COOLING**

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(71) Applicant: **Dell Products L.P.**, Round Rock, TX
(US)

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(72) Inventors: **Tyler Baxter Duncan**, Austin, TX
(US); **Anthony Middleton**, Cedar Park,
TX (US); **Ty Robert Schmitt**, Round
Rock, TX (US)

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(57) **ABSTRACT**

An information handling system includes a chassis that includes a chassis inlet and a chassis outlet and a liquid cooling system that includes a first manifold. The first manifold includes a first chassis outlet configured to provide a first inlet coolant flow to the chassis inlet and a first chassis inlet configured to receive a first outlet coolant flow from the chassis outlet. The liquid cooling system also includes a second manifold that includes a second chassis outlet configured to provide the first inlet coolant flow to the chassis inlet, and a second chassis inlet configured to receive the first outlet coolant flow from the chassis outlet.

Information
Handling System

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